TOSHIBA Photocoupler PHOTORELAY

TLP3241

Measurement Instruments
Logic IC Testers / Memory Testers
Board Testers / Scanners

The TOSHIBA TLP3241 is a super small-outline photorelay, suitable for surface-mount assembly. The TLP3241 consists of an infrared emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Its characteristics also include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency measuring instruments.

Features

• 4 pin SSOP (SSOP4) : 1.8 mm high, 1.27 mm pitch

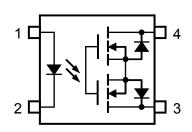
• 1-Form-A

 $\begin{array}{lll} \bullet & \text{Peak off-state voltage} & : 40 \text{ V (min)} \\ \bullet & \text{Trigger LED current} & : 3 \text{ mA (max)} \\ \bullet & \text{On-state current} & : 140 \text{ mA (max)} \\ \bullet & \text{On-state resistance} & : 10\Omega(\text{max}), 7\Omega(\text{typ.}) \\ \bullet & \text{Output capacitance} & : 1.3 \text{ pF (max)}, 0.7 \text{ pF (typ.)} \\ \bullet & \text{Isolation voltage} & : 1500 \text{ Vrms (min)} \\ \end{array}$

• UL-recognized : UL 1577, File No.E67349

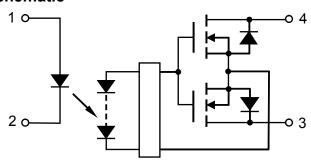
Weight: 0.03 g (typ.)

Pin configuration (top view)



- 1: Anode
- 2 : Cathode
- 3 : Drain
- 4 : Drain

Schematic



Start of commercial production 2007-08

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2019-06-24

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Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit	
	Forward current	lF	30	mA	
	Forward current derating (Ta≥25°C)	ΔI _F /°C	-0.3	mA/°C	
	Reverse voltage	VR	5	V	
۳	Diode power dissipation	P _D	50	mW	
	Diode power dissipation derating (Ta ≥25°C)	ΔP _D /°C	-0.5	mW/°C	
	Junction temperature	Tj	125	°C	
	Off-State output terminal voltage	Voff	40	٧	
	On-State current	Ion	140	mA	
Detector	On-State current derating (Ta≥25°C)	Δlon/°C	-1.4	mA/°C	
Dete	Output power dissipation	Po	196	mW	
	Output power dissipation derating (Ta ≥ 25°C)	ΔP _O /°C	-1.96	mW / °C	
	Junction temperature		125	°C	
Storage temperature range		T _{stg}	-40 to 125	°C	
Operating temperature range		Topr	−20 to 85	°C	
Lead	Lead soldering temperature (10 s)		260	°C	
Isola	tion voltage (AC, 60 s, R.H.≤ 60 %) (Note 1)	BVs	1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

(Note 1): Device considered a two-terminal device: Pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

Precautions

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	V _{DD}	_	_	32	V
Forward current	lF	_	_	20	mA
Operating temperature	T _{opr}	25	_	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 5 mA	1.15	1.30	1.45	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μА
	Capacitance	Ст	V _F = 0 V, f = 1 MHz	_	30	_	pF
Detector	Off-state current	loff	V _{OFF} = 35 V	_	10	200	pА
Dete	Capacitance	C _{OFF}	V = 0 V, f = 100 MHz, t < 1 s	_	0.7	1.3	pF

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Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	I _{ON} = 100 mA	_	_	3	mA
Return LED current	I _{FC}	I _{OFF} = 1 μA	0.1	_	_	mA
On-state resistance	Ron	$I_{ON} = 140 \text{ mA}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	_	7	10	Ω

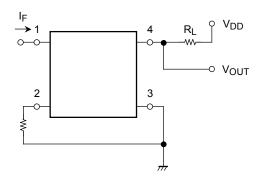
Isolation Characteristics (Ta = 25°C)

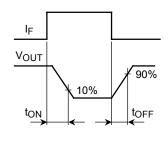
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0 V, f = 1 MHz	_	0.6	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H.≤ 60 %	5 × 10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVs	AC, 60 s	1500	_	-	Vrms

Switching Characteristics (Ta = 25°C)

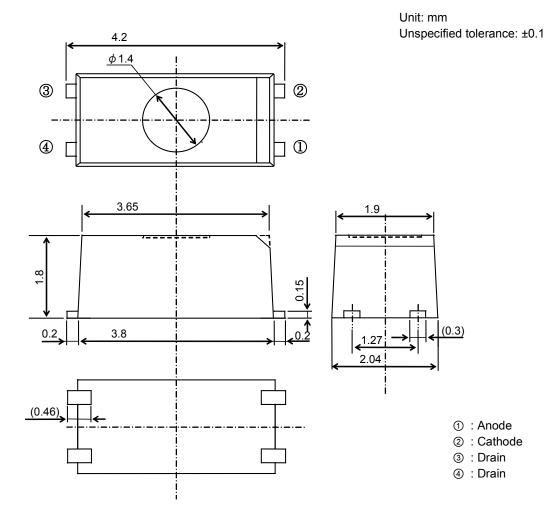
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	$R_L = 200 \Omega$ (Note 2)	_	26	200	0
Turn-off time t_{OFF} $V_{DD} = 10 \text{ V}, I_F = 5 \text{ mA}$		_	45	200	μS	

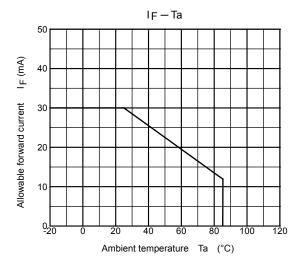
(Note 2): switching time test circuit

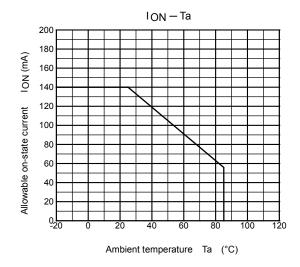


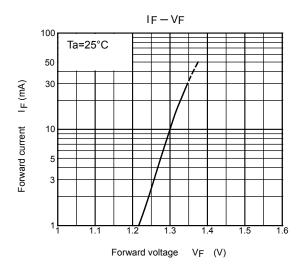


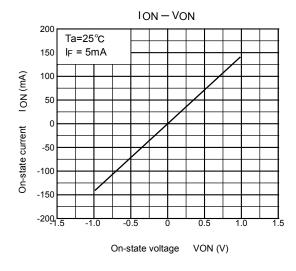
Package Dimensions

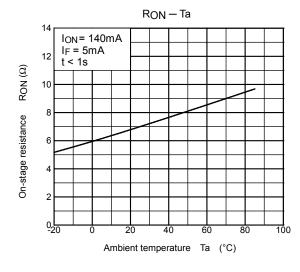


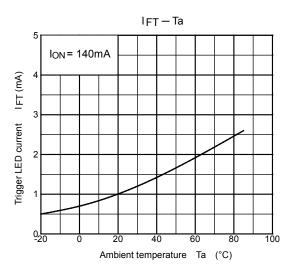




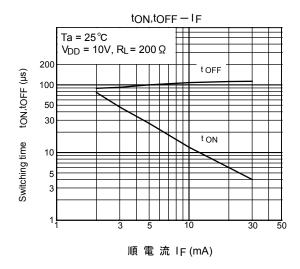


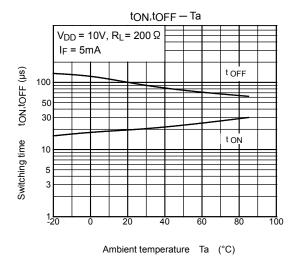


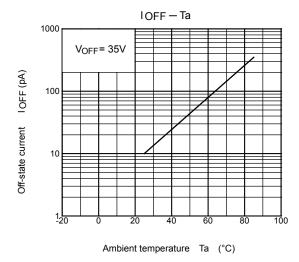




NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.







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